

# DTC113Z series

NPN 100mA 50V Digital Transistor (Bias Resistor Built-in Transistor)

Parameter	Value
V <sub>CC</sub>	50V
I <sub>C(MAX.)</sub>	100mA
R <sub>1</sub>	1.0kΩ
R <sub>2</sub>	10kΩ

## Features

1) Built-In Biasing Resistors,

 $R_1 = 1k\Omega, R_2 = 10k\Omega$ 

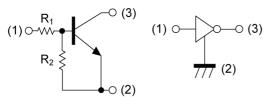
- Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 3) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 4) Complementary PNP Types: DTA113Z series

## Application

INVERTER, INTERFACE, DRIVER

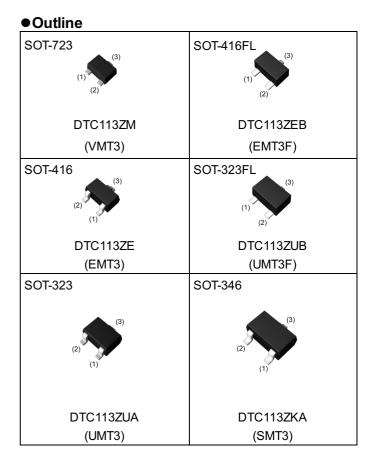
### Inner circuit

DTC113ZM/ DTC113ZEB/ DTC113ZUB

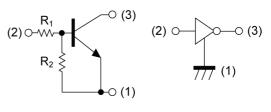


(1) IN (BASE)(2) GND (EMITTER)(3) OUT (COLLECTOR)

### Packaging specifications



## DTC113ZE/ DTC113ZUA/ DTC113ZKA



(1) GND (EMITTER)
(2) IN (BASE)
(3) OUT (COLLECTOR)

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
DTC113ZM	SOT-723	1212	T2L	180	8	8000	E21
DTC113ZEB	SOT-416FL	1616	TL	180	8	3000	E21
DTC113ZE	SOT-416	1616	TL	180	8	3000	E21
DTC113ZUB	SOT-323FL	2021	TL	180	8	3000	121
DTC113ZUA	SOT-323	2021	T106	180	8	3000	121
DTC113ZKA	SOT-346	2928	T146	180	8	3000	E21

## ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

F	Parameter	Symbol	Values	Unit
Supply voltage		V <sub>CC</sub>	50	V
Input voltage		V <sub>IN</sub>	-5 to 10	V
Output current		Ι <sub>Ο</sub>	100	mA
Collector current		I <sub>C(MAX)</sub> *1	100	mA
	DTC113ZM		150	
	DTC113ZEB		150	
Dower discipation	DTC113ZE	P*2	150	
Power dissipation	DTC113ZUB		200	— mW
	DTC113ZUA		200	
	DTC113ZKA		200	
Junction temperature		Tj	150	°C
Range of storage tempera	ature	T <sub>stg</sub>	-55 to +150	°C

## •Electrical characteristics (T<sub>a</sub> = 25°C)

Demonster	Symbol Conditions		Values			1.114
Parameter			Min.	Тур.	Max.	Unit
Innutualtaga	V <sub>I(off)</sub>	V <sub>CC</sub> = 5V, I <sub>O</sub> = 100µA	-	-	0.3	V
Input voltage	V <sub>I(on)</sub>	V <sub>O</sub> = 0.3V, I <sub>O</sub> = 20mA	3.0	-	-	V
Output voltage	V <sub>O(on)</sub>	I <sub>O</sub> = 10mA, I <sub>I</sub> = 0.5mA	-	100	300	mV
Input current	I <sub>I</sub>	V <sub>1</sub> = 5V	-	-	7.2	mA
Output current	I <sub>O(off)</sub>	$V_{CC} = 50V, V_{I} = 0V$	-	-	500	nA
DC current gain	G <sub>I</sub>	V <sub>O</sub> = 5V, I <sub>O</sub> = 5mA	33	-	-	-
Input resistance	R <sub>1</sub>	-	0.7	1.0	1.3	kΩ
Resistance ratio	$R_2/R_1$	-	8	10	12	-
Transition frequency	f <sub>T</sub> *1	V <sub>CE</sub> = 10V, I <sub>E</sub> = -5mA, f = 100MHz	_	250	-	MHz

\*1 Characteristics of built-in transistor

\*2 Each terminal mounted on a reference land.



## •Electrical characteristic curves (T<sub>a</sub> =25°C)

Fig.1 Input voltage vs. output current (ON characteristics)

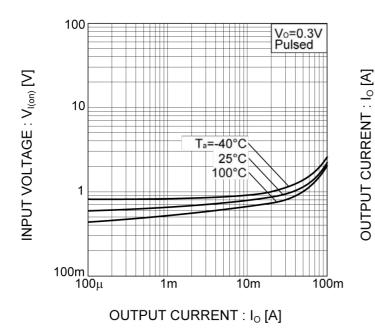


Fig.2 Output current vs. input voltage (OFF characteristics)

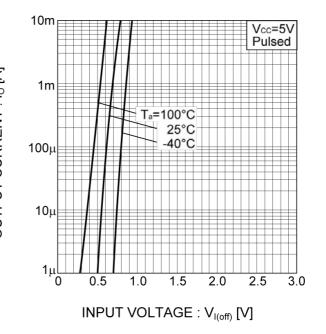


Fig.3 Output current vs. output voltage

OUTPUT CURRENT : I<sub>0</sub> [mA]

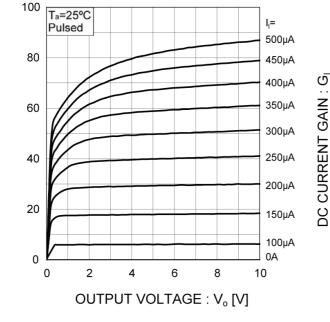
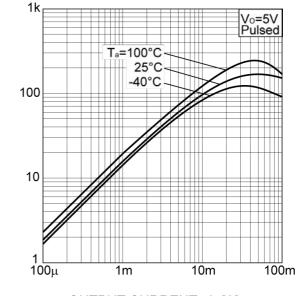
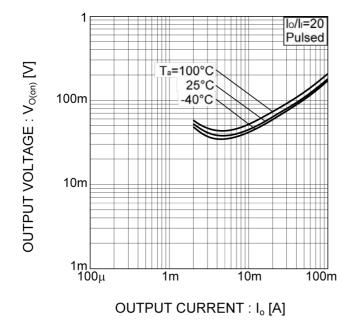


Fig.4 DC current gain vs. output current



OUTPUT CURRENT :  $I_{o}$  [A]

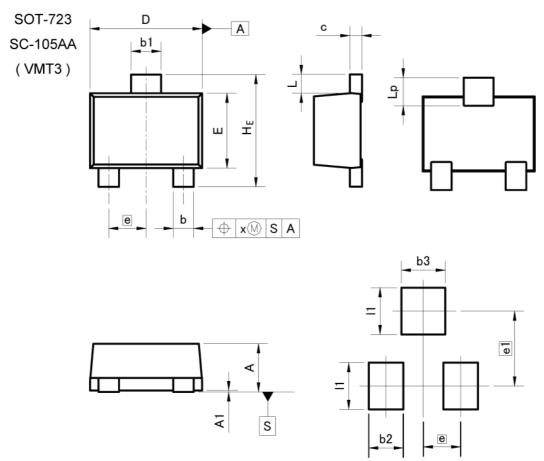
## •Electrical characteristic curves (T<sub>a</sub> =25°C)



## Fig.5 Output voltage vs. output current



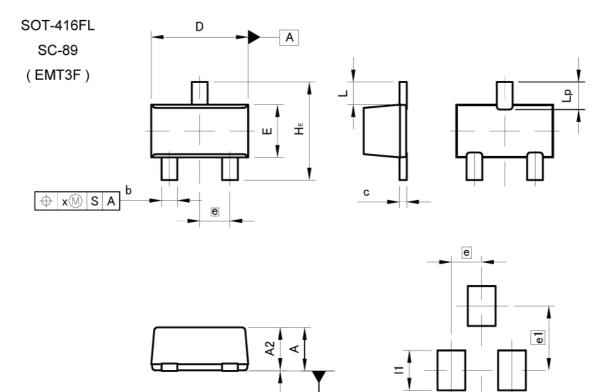




Pattern of terminal position areas [Not a pattern of soldering pads]

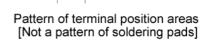
DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
A	0.45	0.55	0.018	0.022
A1	0.00	0.10	0.000	0.004
b	0.17	0.27	0.007	0.011
b1	0.27	0.37	0.011	0.015
с	0.08	0.18	0.003	0.007
D	1.10	1.30	0.043	0.051
E	0.70	0.90	0.028	0.035
е	0.4	40	0.02	
HE	1.10	1.30	0.043	0.051
L	0.10	0.30	0.004	0.012
Lp	0.20	0.40	0.008	0.016
х		0.10		0.004
	MILIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
b2	<u></u> 2	0.37		0.015
b3	<u>144</u> 5	0.47	-	0.019
e1	0.	80	0.0	31
11		0.50	1	0.020





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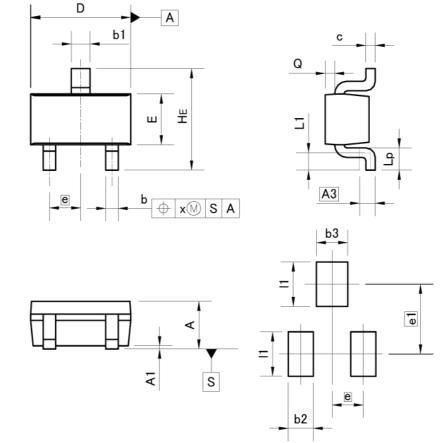
b2

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
A	0.65	0.85	0.026	0.033
A1	0.00	0.10	0.000	0.004
A2	0.60	0.80	0.024	0.031
b	0.21	0.36	0.008	0.014
с	0.08	0.18	0.003	0.007
D	1.50	1.70	0.059	0.067
E	0.76	0.96	0.030	0.038
е	0.	50	0.020	
HE	1.50	1.70	0.059	0.067
L	0.	37	0.015	
Lp	0.35	0.55	0.014	0.022
x		0.10		0.004
	MILIMETERS		INC	HES
	MIN	MAX	MIN	MAX
b2		0.46		0.018
e1		1.05	-	0.041
11	-	0.65	-	0.026





(EMT3)

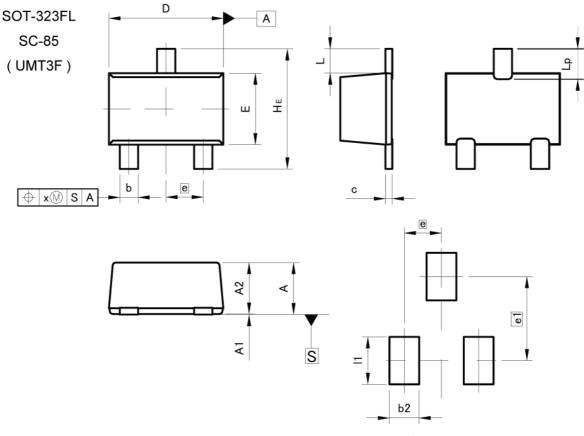


Pattern of terminal position areas [Not a pattern of soldering pads]

	MILIM	ETERS	INCHES	
	MIN	MAX	MIN	MAX
A	0.60	0.80	0.024	0.031
A1	0.00	0.10	0.000	0.004
A3	0.	25	0.0	10
b	0.15	0.30	0.006	0.012
b1	0.25	0.40	0.010	0.016
с	0.10	0.20	0.004	0.008
D	1.50	1.70	0.059	0.067
E	0.70	0.90	0.028	0.035
е	0.	50	0.020	
HE	1.40	1.80	0.055	0.071
L1	0.10		0.004	8 <del></del>
Lp	0.15		0.006	2.55
Q	0.05	0.25	0.002	0.010
x	377	0.10	-	0.004

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
b2		0.40	-	0.016
b3	<del></del>	0.50	. <del></del> (	0.020
e1	1.	10	0.0	043
11	<del></del>	0.70	-	0.028





Pattern of terminal position areas [Not a pattern of soldering pads]

	MILIM	ETERS	INC	HES
	MIN	MAX	MIN	MAX
A	0.85	1.05	0.033	0.041
A1	0.00	0.10	0.000	0.004
A2	0.80	1.00	0.031	0.039
b	0.27	0.42	0.011	0.017
с	0.08	0.18	0.003	0.007
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.	65	0.026	
HE	2.00	2.20	0.079	0.087
L	0.4	25	0.0	17
Lp	0.43	0.63	0.017	0.025
x		0.10		0.004
DIM -	MILIM	ETERS	INC	HES
	100000	212121212		

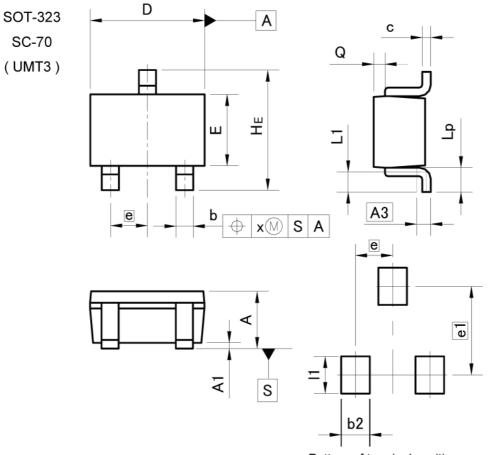
DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
b2	T	0.52	-	0.020
e1	1.4	47	0.0	058
11	5512	0.83	577	0.033

8/10

Dimension in mm/inches



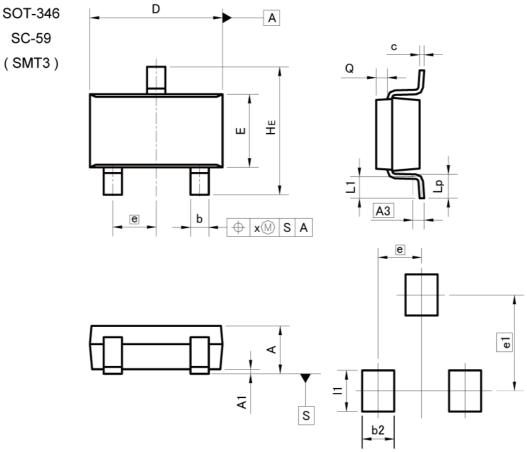
ROHM



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
	MIN	MAX	MIN	MAX
A	0.80	1.00	0.031	0.039
A1	0.00	0.10	0.000	0.004
A3	0.3	25	0.0	10
b	0.25	0.40	0.010	0.016
с	0.10	0.20	0.004	0.008
D	1.90	2.10	0.075	0.083
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L1	0.10	0.40	0.004	0.016
Lp	0.25	0.55	0.010	0.022
Q	0.10	0.30	0.004	0.012
х	=	0.10	-	0.004
	MILIMETERS		INC	HES
	MIN	MAX	MIN	MAX
b2	<u></u> 9	0.50		0.020
e1	1.	55	0.061	
11		0.65	1	0.026





Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INCHES	
	MIN	MAX	MIN	MAX
Α	1.00	1.30	0.039	0.051
A1	0.00	0.10	0.000	0.004
A3	0.	25	0.0	10
b	0.35	0.50	0.014	0.020
С	0.09	0.25	0.004	0.010
D	2.80	3.00	0.110	0.118
E	1.50	1.80	0.059	0.071
е	0.	95	0.037	
HE	2.60	3.00	0.102	0.118
L1	0.30	0.60	0.012	0.024
Lp	0.40	0.70	0.016	0.028
Q	0.20	0.30	0.008	0.012
x		0.10	4 <del></del>	0.004
у	-	0.10	3. <del></del>	0.004
oreorea	MILIMETERS		INCHES	
DIM	MINI	MAX	MINI	MAY

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
b2	-	0.60	27	0.024
e1	2.10		0.083	
11	-10	0.90	( <b>—</b>	0.035



## Notice

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  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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- 3. The information contained in this document is provided on an "as is" basis and ROHM does not warrant that all information contained in this document is accurate and/or error-free. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties resulting from inaccuracy or errors of or concerning such information.

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